Description

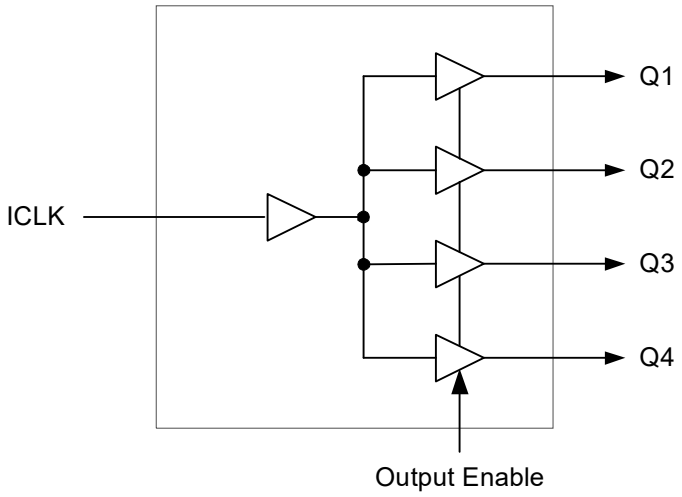
The 651S is a low cost, high-speed single input to four output clock buffer. The 651S has best in class Additive Phase Jitter of sub 50fsec.

IDT makes many non-PLL and PLL based low skew output devices as well as Zero Delay Buffers to synchronize clocks. Contact IDT for all of your clocking needs.

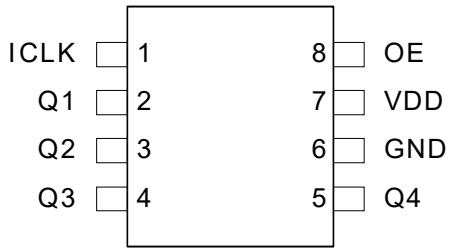
Features

- Low additive phase jitter RMS: 50fs
- Extremely low skew outputs (50ps)
- Low cost clock buffer
- Packaged in 8-pin SOIC and 8-pin DFN, Pb-free
- Input/Output clock frequency up to 200 MHz
- Non-inverting output clock
- Ideal for networking clocks
- Operating Voltages: 1.8V to 3.3V
- Output Enable mode tri-states outputs
- Advanced, low power CMOS process
- Extended temperature range (-40°C to +105°C)

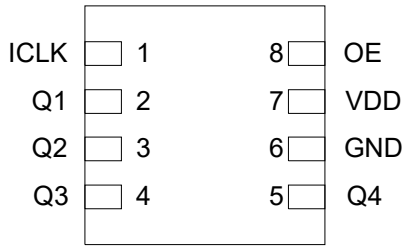
Block Diagram



Pin Assignment



8 Pin (150 mil) SOIC



8-pin DFN

Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	ICLK	Input	Clock input. Internal pull-up resistor.
2	Q1	Output	Clock output 1.
3	Q2	Output	Clock output 2.
4	Q3	Output	Clock output 3.
5	Q4	Output	Clock output 4.
6	GND	Power	Connect to ground.
7	VDD	Power	Connect +1.8V, +2.5V or +3.3V.
8	OE	Input	Output Enable. Tri-states outputs when low. Internal pull-up resistor.

External Components

A minimum number of external components are required for proper operation. A decoupling capacitor of 0.01µF should be connected between VDD on pin 7 and GND on pin 6, as close to the device as possible. A 33Ω series terminating resistor may be used on each clock output if the trace is longer than 1 inch.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 651S. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	3.465V
All Inputs and Outputs	-0.5 V to 3.465V
Ambient Operating Temperature, Extended	-40 to +105°C
Storage Temperature	-65 to +150°C
Junction Temperature	125°C
Soldering Temperature	260°C

Recommended Operation Conditions

Parameter	Min.	Typ.	Max.	Units
Ambient Operating Temperature, Extended	-40	–	+105	°C
Power Supply Voltage (measured in respect to GND)	+1.71		+3.465	V

DC Electrical Characteristics

VDD=1.8 V ±5%, Ambient temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		1.71		1.89	V
Input High Voltage, ICLK	V_{IH}	Note 1	0.7xVDD		1.89	V
Input Low Voltage, ICLK	V_{IL}	Note 1			0.3xVDD	V
Input High Voltage, OE	V_{IH}		0.7xVDD		VDD	V
Input Low Voltage, OE	V_{IL}				0.3xVDD	V
Output High Voltage	V_{OH}	I_{OH} = -10 mA	1.3			V
Output Low Voltage	V_{OL}	I_{OL} = 10 mA			0.35	V
Operating Supply Current	IDD	No load, 135 MHz		13		mA
Nominal Output Impedance	Z_O			17		Ω
Input Capacitance	C_{IN}	OE pin		5		pF

Notes: 1. Nominal switching threshold is VDD/2.

VDD=2.5 V ±5%, Ambient temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		2.375		2.625	V
Input High Voltage, ICLK	V_{IH}	Note 1	0.7xVDD		2.625	V
Input Low Voltage, ICLK	V_{IL}	Note 1			0.3xVDD	V
Input High Voltage, OE	V_{IH}		0.7xVDD		VDD	V
Input Low Voltage, OE	V_{IL}				0.3xVDD	V
Output High Voltage	V_{OH}	I_{OH} = -16 mA	2			V
Output Low Voltage	V_{OL}	I_{OL} = 16 mA			0.3	V
Operating Supply Current	IDD	No load, 135 MHz		18		mA
Nominal Output Impedance	Z_O			17		Ω
Input Capacitance	C_{IN}	OE pin		5		pF

Notes: 1. Nominal switching threshold is VDD/2.

VDD=3.3 V ±5%, Ambient temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	VDD		3.135		3.465	V
Input High Voltage, ICLK	V_{IH}	Note 1	0.7xVDD		3.465	V
Input Low Voltage, ICLK	V_{IL}	Note 1			0.3xVDD	V
Input High Voltage, OE	V_{IH}		0.7xVDD		VDD	V
Input Low Voltage, OE	V_{IL}				0.3xVDD	V
Output High Voltage	V_{OH}	I_{OH} = -25 mA	2.2			V
Output Low Voltage	V_{OL}	I_{OL} = 25 mA			0.7	V
Operating Supply Current	IDD	No load, 135 MHz		22		mA
Nominal Output Impedance	Z_O			17		Ω
Input Capacitance	C_{IN}	OE pin		5		pF

Notes: 1. Nominal switching threshold is VDD/2.

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AC Electrical Characteristics

VDD=1.8V ±5%, Ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Output Frequency		5pF load, Note 4			200	MHz
Output Clock Rise Time	t_{OR}	0.36 to 1.44 V		0.6	1.0	ns
Output Clock Fall Time	t_{OF}	1.44 to 0.36V		0.6	1.0	ns
Start-up Time	$t_{START-UP}$	Part start-up time for valid outputs after VDD ramp-up			2	ms
Propagation Delay		135 MHz, Note 1	1.5	2	4	ns
Buffer Additive Phase Jitter, RMS		125MHz, Integration range: 12kHz–20MHz			0.05	ps
Output to Output Skew		Rising edges at VDD/2, Note 2		50	65	ps
Output Enable Time	t_{EN}	$C_L \leq 5pF$			3	cycles
Output Disable Time	t_{DIS}	$C_L \leq 5pF$			3	cycles

VDD=2.5V ±5%, Ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Output Frequency		5pF load, Note 4			200	MHz
Output Clock Rise Time	t_{OR}	0.5 to 2.0V		0.6	1.0	ns
Output Clock Fall Time	t_{OF}	2.0 to 0.5V		0.6	1.0	ns
Start-up Time	$t_{START-UP}$	Part start-up time for valid outputs after VDD ramp-up			2	ms
Propagation Delay		135 MHz, Note 1	1.8	2.5	4.5	ns
Buffer Additive Phase Jitter, RMS		125MHz, Integration range: 12kHz–20MHz			0.05	ps
Output to Output Skew		Rising edges at VDD/2, Note 2		50	65	ps
Output Enable Time	t_{EN}	$C_L \leq 5pF$			3	cycles
Output Disable Time	t_{DIS}	$C_L \leq 5pF$			3	cycles

VDD=3.3 V ±5%, Ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Output Frequency		5pF load, Note 4			200	MHz
Output Clock Rise Time	t_{OR}	0.66 to 2.64V		0.6	1.0	ns
Output Clock Fall Time	t_{OF}	2.64 to 0.66V		0.6	1.0	ns
Start-up Time	$t_{START-UP}$	Part start-up time for valid outputs after VDD ramp-up			2	ms
Propagation Delay		135 MHz, Note 1	1.5	2	4	ns
Buffer Additive Phase Jitter, RMS		125MHz, Integration range: 12kHz–20MHz			0.05	ps
Output to Output Skew		Rising edges at VDD/2, Note 2		50	65	ps
Output Enable Time	t_{EN}	$C_L \leq 5pF$			3	cycles
Output Disable Time	t_{DIS}	$C_L \leq 5pF$			3	cycles

Notes:
1. With rail to rail input clock.
2. Between any 2 outputs with equal loading.
3. Duty cycle on outputs will match incoming clock duty cycle. Consult IDT for tight duty cycle clock generators.
4. With external series resistor of 33Ω positioned close to each output pin.

Phase Noise Plots

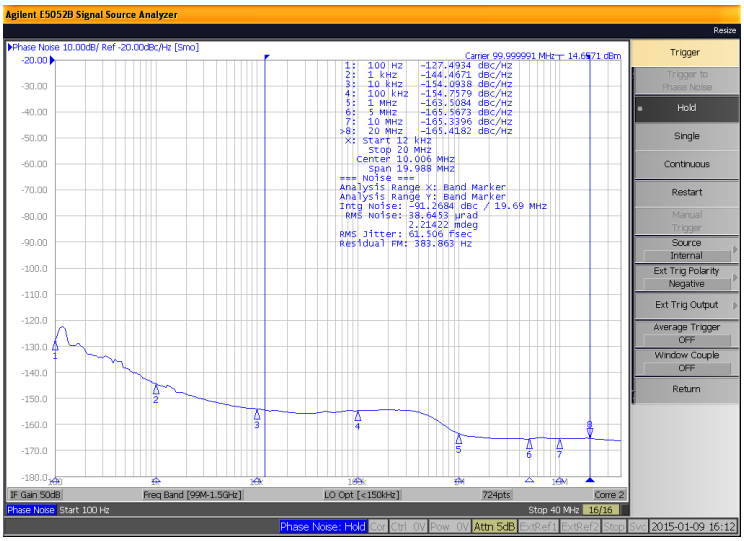


Figure 1. 651S Reference Phase Noise 62fs (12kHz to 20MHz)

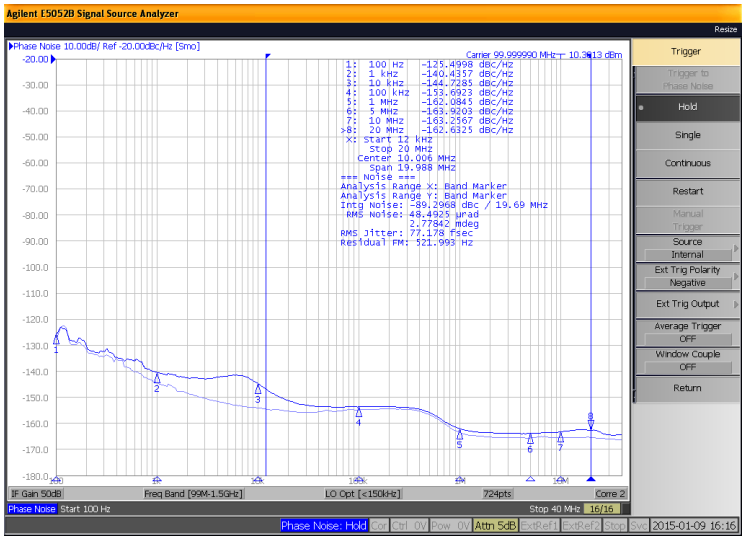
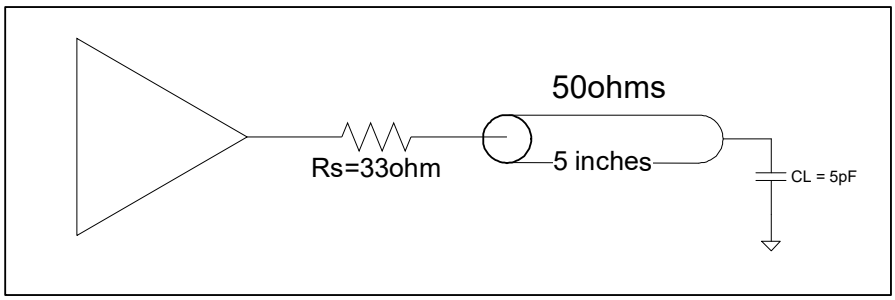


Figure 2. 651S Output Phase Noise 77fs (12kHz to 20MHz)

The phase noise plots above show the low Additive Jitter of the 651S high-performance buffer. With an integration range of 12kHz to 20MHz, the reference input has about 62fs of RMS phase jitter while the output of 651S has about 77fs of RMS phase jitter. This results in a low Additive Phase Jitter of only 45fs.

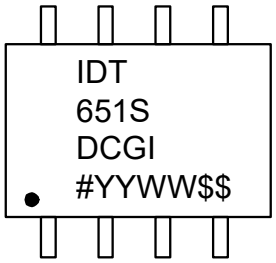
Test Load and Circuit



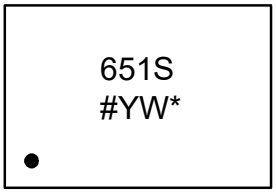
Thermal Characteristics (8SOIC)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Thermal Resistance Junction to Ambient	θ_{JA}	Still air		150		°C/W
	θ_{JA}	1 m/s air flow		140		°C/W
	θ_{JA}	3 m/s air flow		120		°C/W
Thermal Resistance Junction to Case	θ_{JC}			40		°C/W

Marking Diagrams



8-pin SOIC

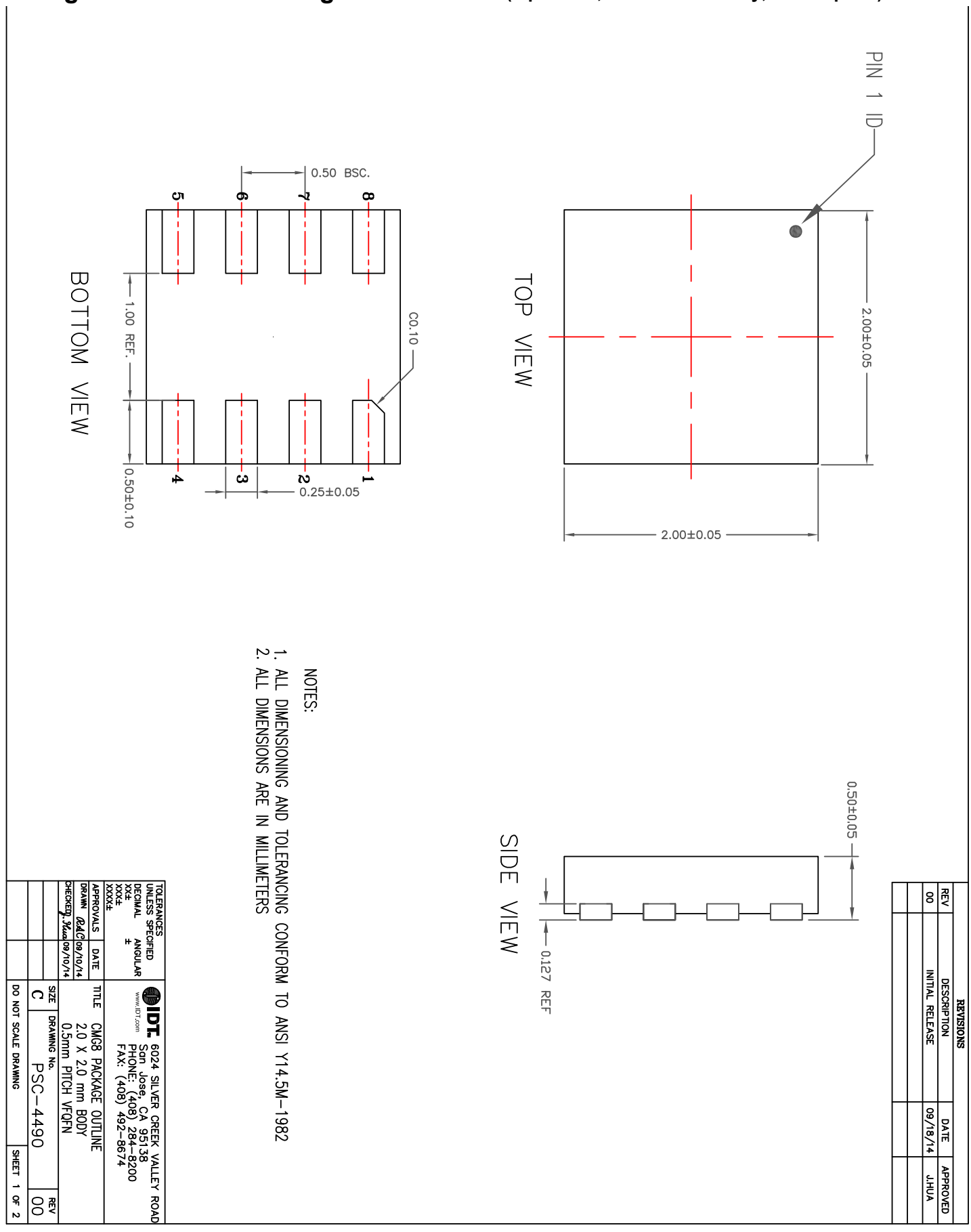


8-pin DFN

Notes:

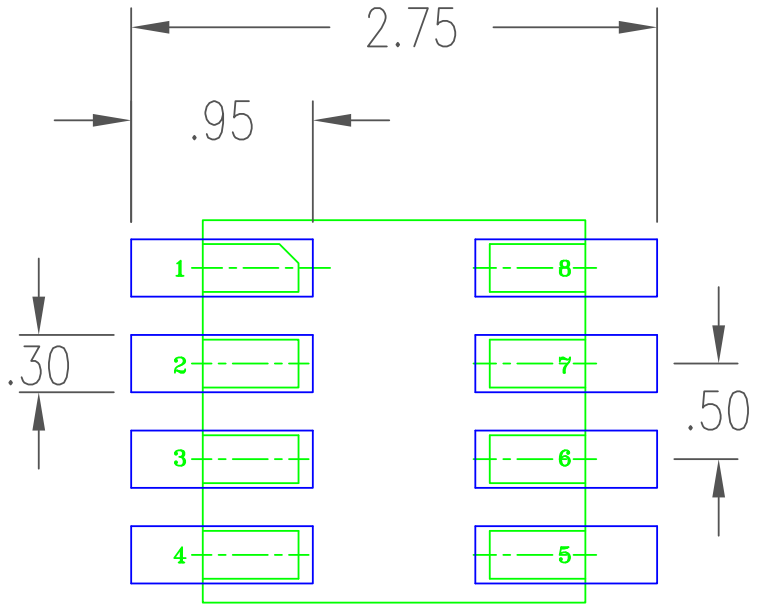
1. "*" is the lot number.
2. "YYWW" or "YW" are the last digits of the year and week that the part was assembled.
3 "G" denotes RoHS compliant package.
4. "$" denotes the mark code.
5. "I" denotes extended temperature range device.
6. "#" is the stepping number.

Package Outline and Package Dimensions (8-pin DFN, 2mm x 2mm Body, 0.5mm pitch)



Package Outline and Package Dimensions, cont. (8-pin DFN, 2mm x 2mm Body, 0.5mm pitch)

REVISIONS			
REV	DESCRIPTION	DATE	APP
00	INITIAL RELEASE	09/18/14	J.



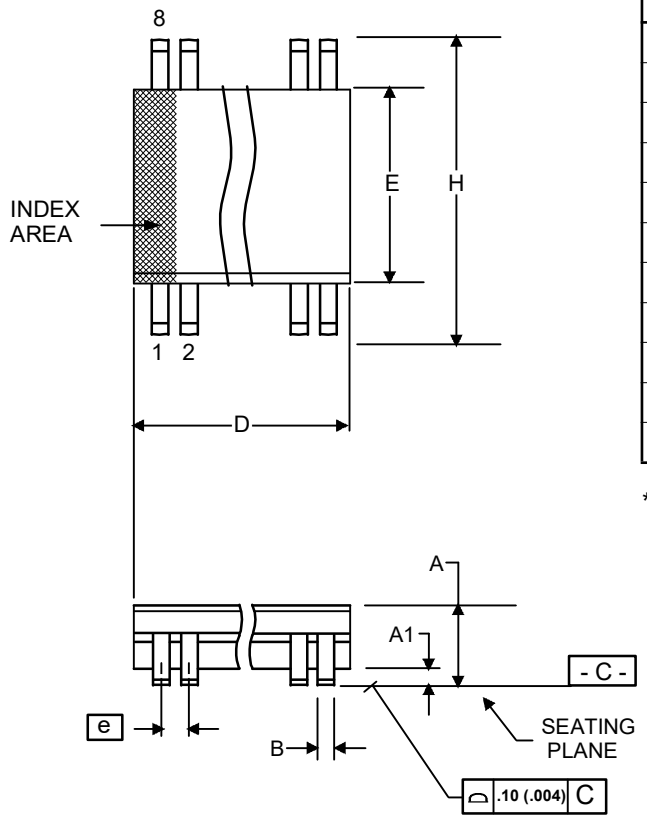
RECOMMENDED LAND PATTERN DIMENSION

NOTES:
1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR MOUNT DESIGN AND LAND PATTERN.

TOLERANCES UNLESS SPECIFIED DECIMAL ANGULAR XX± ± XXX± XXXX±		IDT. www.IDT.com	6024 SILVER CREEK VALLE San Jose, CA 95138 PHONE: (408) 284-8200 FAX: (408) 492-8674
APPROVALS	DATE	TITLE	CMG8 PACKAGE OUTLINE 2.0 X 2.0 mm BODY 0.5 mm PITCH VFQFN
DRAWN RdC	09/10/14		
CHECKED		SIZE C	DRAWING No. PSC-4490
		DO NOT SCALE DRAWING	SHEET

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Package Outline and Package Dimensions (8-pin SOIC, 150 Mil. Narrow Body)



	Millimeters		Inches*	
Symbol	**Min**	**Max**	**Min**	**Max**
A	1.35	1.75	.0532	.0688
A1	0.10	0.25	.0040	.0098
B	0.33	0.51	.013	.020
C	0.19	0.25	.0075	.0098
D	4.80	5.00	.1890	.1968
E	3.80	4.00	.1497	.1574
e	1.27 BASIC		0.050 BASIC	
H	5.80	6.20	.2284	.2440
h	0.25	0.50	.010	.020
L	0.40	1.27	.016	.050
a	0°	8°	0°	8°

*For reference only. Controlling dimensions in mm.

Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
651SDCGI	see page 7	Tubes	8-pin SOIC	-40 to +105 °C
651SDCGI8		Tape and Reel	8-pin SOIC	-40 to +105 °C
651SCMGI		Cut Tape	8-pin DFN	-40 to +105 °C
651SCMGI8		Tape and Reel	8-pin DFN	-40 to +105 °C

“G” suffix to the part number denotes Pb-Free configuration, RoHS compliant.

Revision History

Date	Description of Change
08/14/2026	• Updated Marking Diagrams. • Rebranded datasheet from IDT to Renesas.
03/18/15	Initial release.

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